# 查询"MRF644"供应商 The RF Line

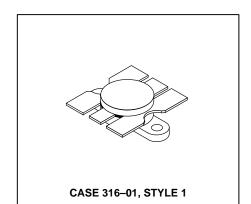
# **NPN Silicon RF Power Transistor**

. . . designed for 12.5 Volt UHF large-signal amplifier applications in industrial and commercial FM equipment operating to 512 MHz.

- Specified 12.5 Volt, 470 MHz Characteristics Output Power = 25 Watts Minimum Gain = 6.2 dB Efficiency = 60%
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- Built-In Matching Network for Broadband Operation
- Tested for Load Mismatch Stress at all Phase Angles with 20:1 VSWR @ 16-Volt High Line and 50% Overdrive
- · Circuit board photomaster available upon request by contacting RF Tactical Marketing in Phoenix, AZ.

## **MRF644**

25 W, 470 MHz **CONTROLLED Q RF POWER TRANSISTOR NPN SILICON** 



#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	VCEO	16	Vdc
Collector–Base Voltage	VCBO	36	Vdc
Emitter-Base Voltage	VEBO	4.0	Vdc
Collector Current — Continuous	IC	4.0	Adc
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	103 0.59	Watts W/°C
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.7	°C/W

#### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage (I <sub>C</sub> = 20 mAdc, I <sub>B</sub> = 0)	V(BR)CEO	16	_	_	Vdc
Collector–Emitter Breakdown Voltage (I <sub>C</sub> = 20 mAdc, V <sub>BE</sub> = 0)	V(BR)CES	36	_	_	Vdc
Emitter–Base Breakdown Voltage (IE = 5.0 mAdc, IC = 0)	V(BR)EBO	4.0	_	_	Vdc
Collector Cutoff Current (VCE = 15 Vdc, VBE = 0, TC = 25°C)	ICES	_	_	5.0	mAdc

(continued)



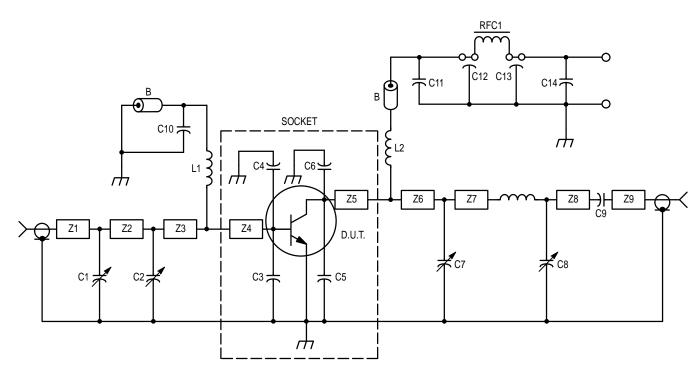


### **ELECTRICAL CHARACTERISTICS** — **continued** $(T_C = 25^{\circ}C)$ unless otherwise noted.)

查询"MRF644"供应 <b>簡</b> aracteristic	Symbol	Min	Тур	Max	Unit
ON CHARACTERISTICS					
DC Current Gain (IC = 4.0 Adc, VCE = 5.0 Vdc)	hFE	40	70	100	
DYNAMIC CHARACTERISTICS					
Output Capacitance (V <sub>CB</sub> = 12.5 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>ob</sub>	_	60	85	pF
FUNCTIONAL TESTS					
Common–Emitter Amplifier Power Gain (V <sub>CC</sub> = 12.5 Vdc, P <sub>Out</sub> = 25 W, I <sub>C</sub> (MAX) = 3.6 Adc, f = 470 MHz)	G <sub>pe</sub>	6.2	7.0	_	dB
Input Power (V <sub>CC</sub> = 12.5 Vdc, P <sub>out</sub> = 25 W, f = 470 MHz)	P <sub>in</sub>	_	5.0	6.0	Watts
Collector Efficiency (V <sub>CC</sub> = 12.5 Vdc, P <sub>Out</sub> = 25 W, I <sub>C</sub> (MAX) = 3.6 Adc, f = 470 MHz)	η	55	60	_	%
Output Mismatch Stress (V <sub>CC</sub> = 16 Vdc, P <sub>in</sub> = Note 1, f = 470 MHz, VSWR = 20:1, All Phase Angles)	Ψ*	No Degradation in Output Power			
Series Equivalent Input Impedance (V <sub>CC</sub> = 12.5 Vdc, P <sub>Out</sub> = 25 W, f = 470 MHz)	Z <sub>in</sub>		1.2 + j3.3		Ohms
Series Equivalent Output Impedance (V <sub>CC</sub> = 12.5 Vdc, P <sub>out</sub> = 25 W, f = 470 MHz)	Z <sub>OL</sub>	_	1.9 + j2.1	_	Ohms

#### NOTE:

<sup>\*</sup>  $\psi$  = Mismatch stress factor — the electrical criterion established to verify the device resistance to load mismatch failure. The mismatch stress test is accomplished in the standard test fixture (Figure 1) terminated in a 20:1 minimum load mismatch at all phase angles.



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C1, C2, C7, C8 — 1.0-20 pF Johanson Variable
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C3 — 27 pF 100 mil ATC

C4 — 30 pF 100 mil ATC

C5, C6 — 33 pF 100 mil ATC

C9 - 250 pF 100 mil ATC

C10 — 100 pF UNELCO

C11, C14 — 1.0  $\mu$ F 35 V TANTALUM

C12, C13 — 680 pF Feedthrough L1 - 5" #22 AWG 0.100" ID

L2 — 5" #20 AWG 0.187" ID RFC1 — Ferroxcube VK200-20-4B B — Ferroxcube Bead 56-590-65-3B

Z1 — 0.25" x 0.20" Microstrip

Z2 — 1.63" x 0.20" Microstrip

Z3 — 0.20" x 0.20" Microstrip

Z4, Z5 — 1/2" #18 AWG bent in a "V" shape 1/8" Wide

Z6 — 0.20" x 0.20" Microstrip

Z7 — 0.70" x 0.20" Microstrip

Z8 — 0.33" x 0.20" Microstrip

Z9 — 0.50" x 0.20" Microstrip

Board — 62.5 mil Glass Teflon,  $\varepsilon_r$  = 2.55

Figure 1. Test Circuit Schematic

<sup>1.</sup> Pin = 150% of Drive Requirement for 25 W Output at 12.5 Vdc.

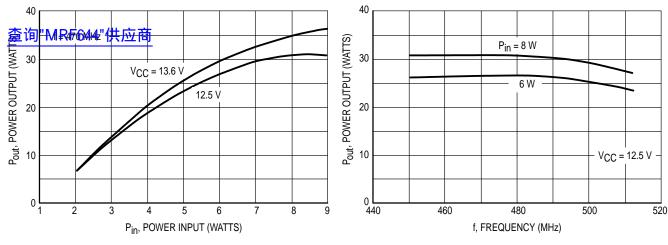


Figure 2. Power Output versus Power Input

Figure 3. Power Output versus Frequency

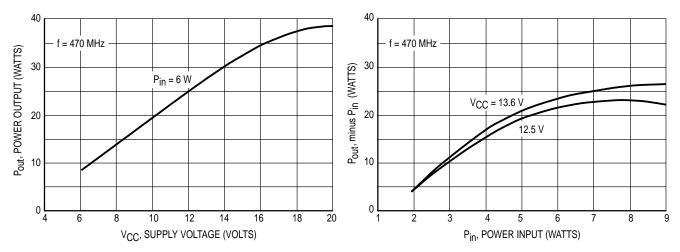
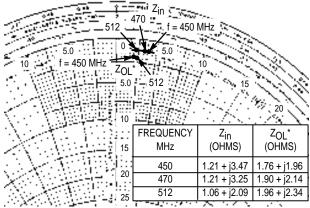


Figure 4. Power Output versus Supply Voltage

Figure 5. Power Saturation Profile

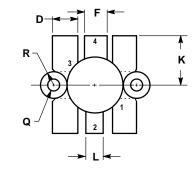


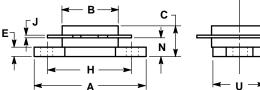
 $Z_{OL}^*$  = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency.

Figure 6. Series Equivalent Input-Output Impedance

#### **PACKAGE DIMENSIONS**

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NOTES:

1. FLANGE IS ISOLATED IN ALL STYLES.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	24.38	25.14	0.960	0.990	
В	12.45	12.95	0.490	0.510	
С	5.97	7.62	0.235	0.300	
D	5.33	5.58	0.210	0.220	
E	2.16	3.04	0.085	0.120	
F	5.08	5.33	0.200	0.210	
Н	18.29	18.54	0.720	0.730	
J	0.10	0.15	0.004	0.006	
K	10.29	11.17	0.405	0.440	
L	3.81	4.06	0.150	0.160	
N	3.81	4.31	0.150	0.170	
Q	2.92	3.30	0.115	0.130	
R	3.05	3.30	0.120	0.130	
U	11.94	12.57	0.470	0.495	

STYLE 1:

PIN 1. EMITTER

2. COLLECTOR 3. EMITTER

4. BASE

CASE 316-01 ISSUE D

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